



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C		
001/	50mΩ @ V _{GS} = -10V	-4.5A		
-30V	$75m\Omega$ @ $V_{GS} = -4.5V$	-3.7A		

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP3050LVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

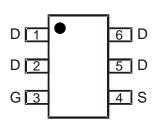
- Backlighting
- Power management functions
- DC-DC converters

Mechanical Data

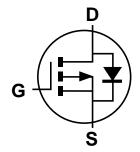
- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013grams (Approximate)







Device Schematic



Equivalent Circuit

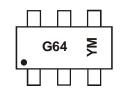
Ordering Information (Note 4)

Port Number	Bookago	Packing		
Part Number	Package	Qty.	Carrier	
DMP3050LVTQ-7	TSOT26	3000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



G64 = Product Type Marking Code YM = Date Code Marking Y or Y = Year (ex: J = 2022) M = Month (ex: 1 = January)

Date Code Key

ale eeae . lej												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н	ı	J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit		
Drain-Source Voltage		V_{DSS}	-30	V		
Gate-Source Voltage (Note 5)		Vgss	±25	V		
	Steady T _A = +25°C			-4.5	^	
	State	T _A = +70°C	l _D	-3.5	А	
Continuous Drain Current (Note 6) V _{GS} = -10V	t<10s	T _A = +25°C		-5.2	А	
		T _A = +70°C	l _D	-4.1		
Maximum Continuous Body Diode Forward Current	Is	-2	Α			
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-25	Α	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	T _A = +25°C	ק	1.6	W
Total Power Dissipation (Note 6)	$T_A = +70$ °C	P_D	1.0	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	5	78	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	49	°C/W
Thermal Resistance, Junction to Case (Note 6) Steady St		R _θ JC	13	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

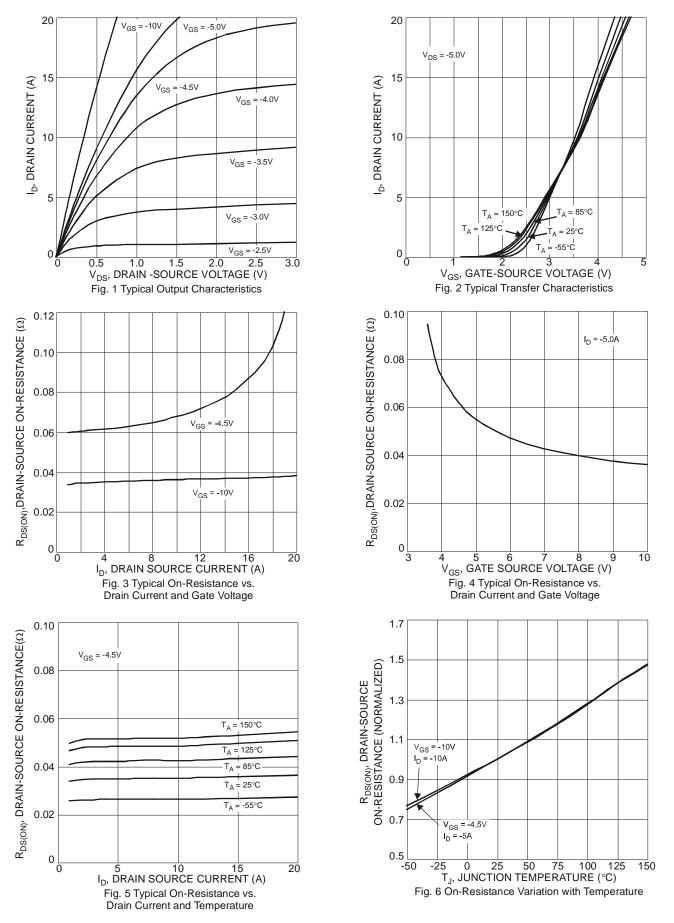
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)		I	71				
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	$V_{DS} = -30V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	-1.0	1	-2.0	٧	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Dagger	_	36	50	m 0	$V_{GS} = -10V, I_D = -4.5A$	
Static Drain-Source On-Resistance	RDS(ON)	_	56	75	mΩ	$V_{GS} = -4.5V$, $I_{D} = -3A$	
Forward Transfer Admittance	Y _{fs}	_	7.2	_	S	$V_{DS} = -5V, I_{D} = -5A$	
Diode Forward Voltage	VsD	_	-0.7	-1.0	V	$V_{GS} = 0V$, $I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	620	_	pF		
Output Capacitance	Coss	_	83	_	pF	V _{DS} = -15V, V _{GS} = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	62	_	pF	1 = 1.001112	
Gate Resistance	Rg	_	10.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (Vgs = -4.5V)	Qg	_	5.1	_	nC		
Total Gate Charge (Vgs = -10V)	Qg	_	10.5	_	nC	Vps = -15V. lp = -6A	
Gate-Source Charge	Qgs	_	1.8	_	nC	VDS = -15V, ID = -6A	
Gate-Drain Charge	Q_{gd}	_	1.9	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	6.8	_	ns		
Turn-On Rise Time	t _R	_	4.9	_	ns	V _{DD} = -15V, V _{GS} = -10V,	
Turn-Off Delay Time	t _{D(OFF)}	_	28.4	_	ns	$R_g = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	tF	_	12.4	_	ns	7	

Notes:

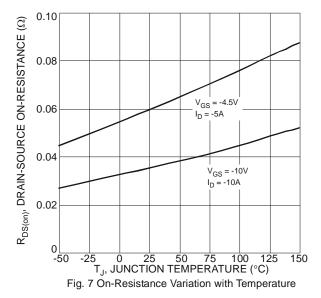
- 5. AEC-Q101 $V_{\rm GS}$ maximum is ±20V. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

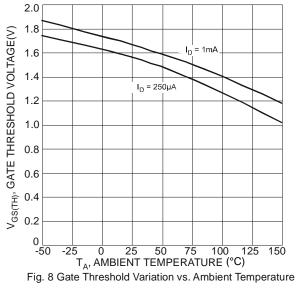


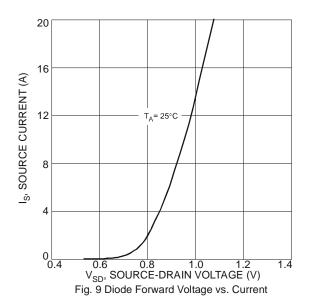


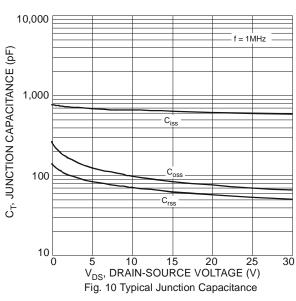


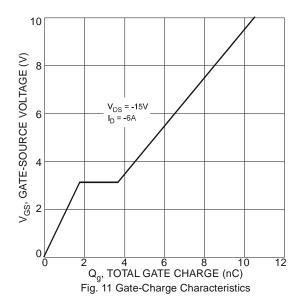


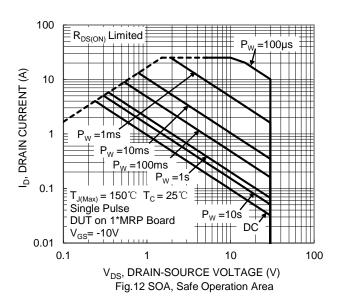














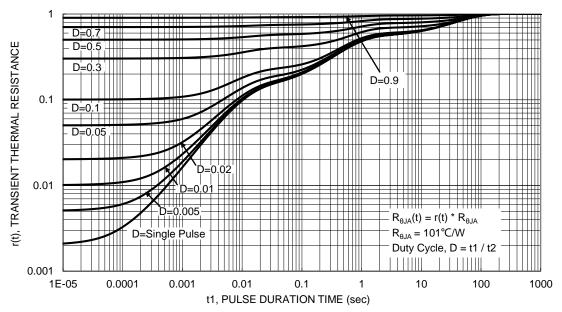


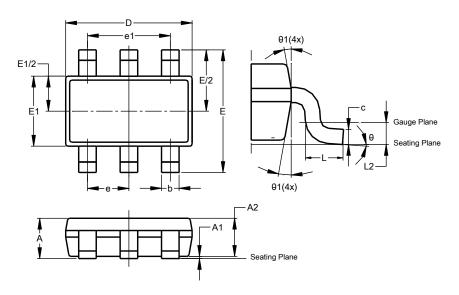
Fig. 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

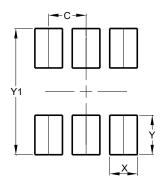


TSOT26								
Dim	Min	Тур						
Α	-	1.00	-					
A 1	0.010	0.100	-					
A2	0.840	0.900	-					
ם	2.800	3.000	2.900					
Е	2	.800 BS	С					
E1	1.500	1.700	1.600					
b	0.300	0.450	=					
С	0.120	0.200	-					
е	0.950 BSC							
e1	1	1.900 BSC						
L	0.30 0.50 -							
L2	0	0.250 BSC						
θ	0°	8°	4°					
θ1	4°	12°	_					
Α	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3 200



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